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Docket No.: 80300(302750)  
(PATENT)

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Kei Murayama

Application No.: 10/709,138

Confirmation No.: 3137

Filed: April 15, 2004

Art Unit: 1792

For: ELECTROLESS PLATING METHOD

Examiner: K. A. Bareford

### AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

### INTRODUCTORY COMMENTS

In response to the Office Action dated May 20, 2008, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.